

# Polar3<sup>™</sup> HiPerFET<sup>™</sup> Power MOSFET

## IXFK150N30P3 IXFX150N30P3

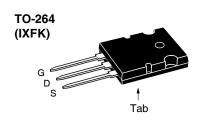
N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

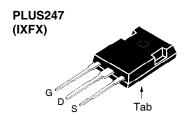


Symbol	Test Conditions	Maximum F	Ratings
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 150°C	300	V
V <sub>DGR</sub>	$T_{_{\rm J}} = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}, R_{_{\rm GS}} = 1\text{M}\Omega$	300	V
V <sub>GSS</sub>	Continuous	± 20	V
V <sub>GSM</sub>	Transient	± 30	V
I <sub>D25</sub>	T <sub>C</sub> = 25°C	150	Α
I <sub>DM</sub>	$T_{c} = 25^{\circ}C$ , Pulse Width Limited by $T_{JM}$	375	Α
IA	$T_{c} = 25^{\circ}C$	75	Α
I <sub>A</sub> E <sub>AS</sub>	$T_{c} = 25^{\circ}C$	4	J
$\mathbf{P}_{_{\mathrm{D}}}$	T <sub>C</sub> = 25°C	1300	W
dv/dt	$I_{_{S}} \le I_{_{DM}}, \ V_{_{DD}} \le V_{_{DSS}}, \ T_{_{J}} \le 150^{\circ}C$	35	V/ns
T		-55 +150	°C
T <sub>IM</sub>		150	°C
T <sub>stg</sub>		-55 +150	°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering	300	°C
T <sub>SOLD</sub>	1.6 mm (0.062in.) from Case for 10s	260	°C
M <sub>d</sub>	Mounting Torque (TO-264)	1.13/10	Nm/lb.in
F <sub>c</sub>	Mounting Force (PLUS247)	20120 /4.527	N/lb
Weight	TO-264	10	g
	PLUS247	6	<u>g</u>

			cteristic	Values Max	
$(I_J = 25 \text{ C})$	onless Otherwise Specified)	Min.	Тур.	IVIAX	·
BV <sub>DSS</sub>	$V_{GS} = 0V, I_{D} = 3mA$	300			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 8mA$	3.0		5.0	V
I <sub>GSS</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$			± 200	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}, V_{GS} = 0V$			25	μА
	T <sub>J</sub> = 125°	C		1	mA
R <sub>DS(on)</sub>	$V_{GS} = 10V, I_{D} = 0.5 \cdot I_{D25}, Note 1$			19	mΩ

 $\begin{array}{lll} \textbf{V}_{\text{DSS}} & = & 300 \textbf{V} \\ \textbf{I}_{\text{D25}} & = & 150 \textbf{A} \\ \textbf{R}_{\text{DS(on)}} & \leq & 19 m \Omega \\ \textbf{t}_{\text{rr}} & \leq & 250 \text{ns} \end{array}$ 





G	=	Gate	D	=	Drain
S	=	Source	Tab	=	Drain

#### **Features**

- Dynamic dv/dt Rating
- Avalanche Rated
- Fast Intrinsic Diode
- Low Q<sub>G</sub>
- Low R<sub>DS(on)</sub>
- Low Drain-to-Tab Capacitance
- Low Package Inductance

#### **Advantages**

- Easy to Mount
- Space Savings

#### **Applications**

- DC-DC Converters
- Battery Chargers
- Switch-Mode and Resonant-Mode Power Supplies
- Uninterrupted Power Supplies
- AC Motor Drives
- High Speed Power Switching Applications



Symbol Test Conditions Characteristics Charact		cteristic Values		
$(T_J = 25^{\circ}C$	Unless Otherwise Specified)	Min.	Тур.	Max.
g <sub>fs</sub>	$V_{DS} = 10V, I_{D} = 60A, Note 1$	65	110	S
C <sub>iss</sub>			12.1	nF
C <sub>oss</sub>	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		1910	pF
C <sub>rss</sub>			40	pF
$\mathbf{R}_{Gi}$	Gate Input Resistance		1.0	Ω
t <sub>d(on)</sub>	Resistive Switching Times		44	ns
t,	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		30	ns
t <sub>d(off)</sub>	$R_{G} = 10$ (External)		74	ns
<b>t</b> , <i>J</i>			12	ns
$\mathbf{Q}_{g(on)}$			197	nC
Q <sub>gs</sub>	$V_{_{\mathrm{GS}}} = 10 \mathrm{V},  V_{_{\mathrm{DS}}} = 0.5 \bullet V_{_{\mathrm{DSS}}},  I_{_{\mathrm{D}}} = 0.5 \bullet I_{_{\mathrm{D25}}}$		70	nC
$Q_{gd}$			65	nC
R <sub>thJC</sub>	_			0.096 °C/W
R <sub>thCS</sub>			0.15	°C/W

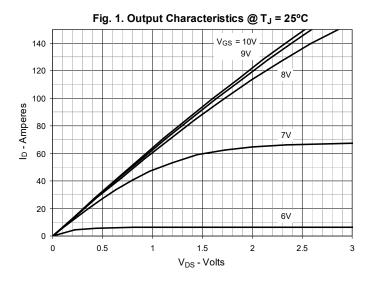
#### Source-Drain Diode

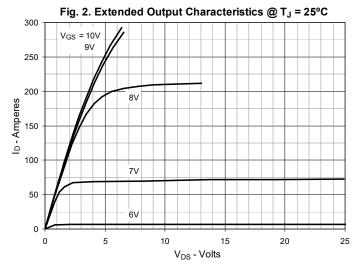
Symbol Test Conditions		Char	Characteristic Values			
$(T_{J} = 2)$	25°C, L	Inless Otherwise Specified)	Min.	Тур.	Max.	
I <sub>s</sub>		$V_{GS} = 0V$			150	Α
I <sub>SM</sub>		Repetitive, Pulse Width Limited by $T_{_{\rm JM}}$			600	Α
V <sub>sD</sub>		$I_{\rm F}$ = 100A , $V_{\rm GS}$ = 0V, Note 1			1.5	V
t <sub>rr</sub>	)	I <sub>ε</sub> = 75A, -di/dt = 100A/μs			250	ns
$\mathbf{Q}_{_{\mathrm{RM}}}$	}	•		2.9		μC
I <sub>RM</sub>	J	$V_R = 100V, V_{GS} = 0V$		23.0		Α

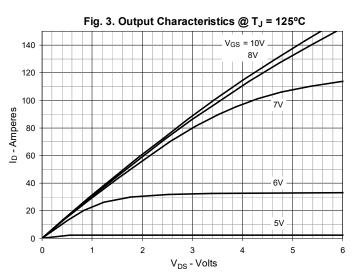
Note 1. Pulse test,  $t \le 300 \mu s$ , duty cycle,  $d \le 2\%$ .

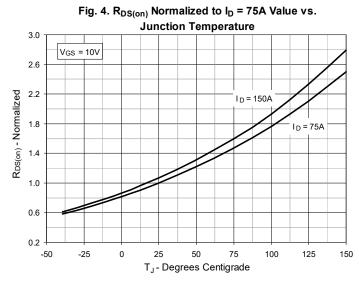
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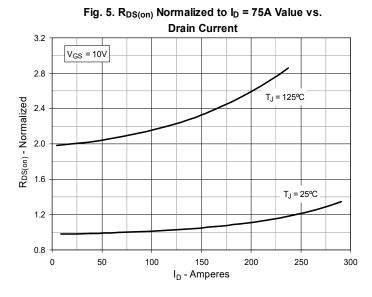


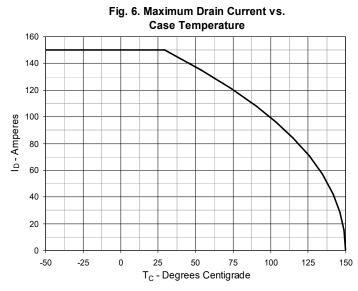




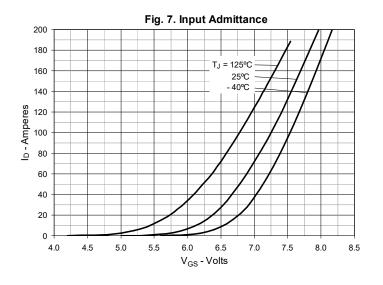


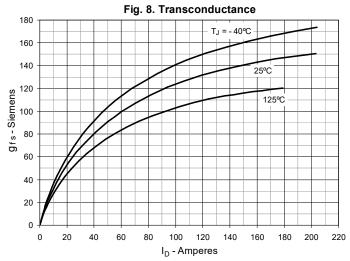


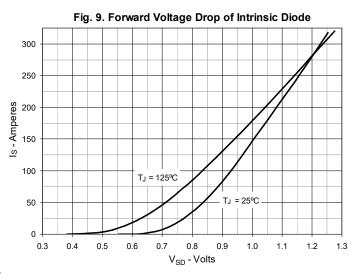


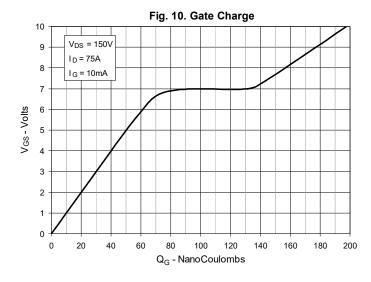


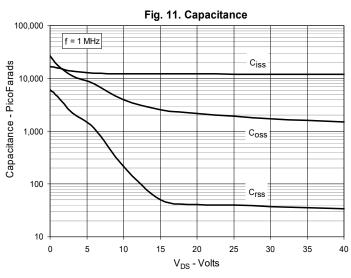


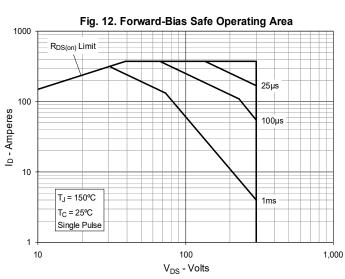












IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.

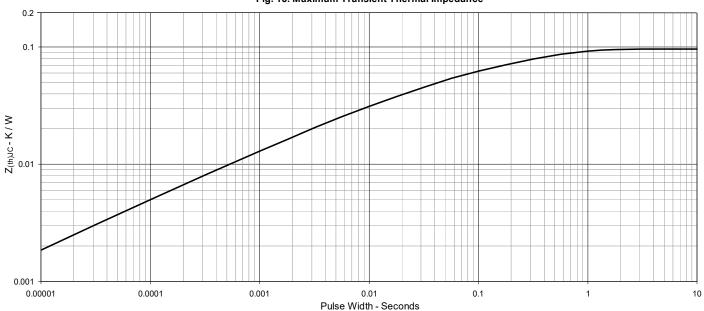
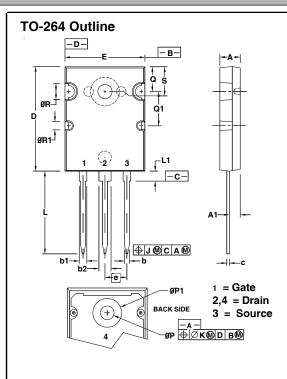


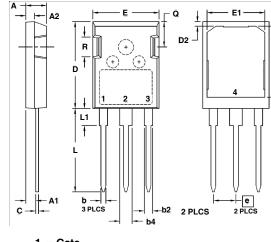
Fig. 13. Maximum Transient Thermal Impedance





SYMBOL	INCHES		MILLIMETERS	
SIMBOL	MIN	MAX	MIN	MAX
Α	.185	.209	4.70	5.31
A1	.102	.118	2.59	3.00
b	.037	.055	0.94	1.40
b1	.087	.102	2.21	2.59
b2	.110	.126	2.79	3.20
С	.017	.029	0.43	0.74
D	1.007	1.047	25.58	26.59
E	.760	.799	19.30	20.29
е	.215	BSC	5.46 BSC	
J	.000	.010	0.00	0.25
K	.000	.010	0.00	0.25
١	.779	.842	19.79	21.39
L1	.087	.102	2.21	2.59
ØΡ	.122	.138	3.10	3.51
øP1	.270	.290	6.86	7.37
Q	.240	.256	6.10	6.50
Q1	.330	.346	8.38	8.79
ØR	.155	.187	3.94	4.75
ØR1	.085	.093	2.16	2.36
S	.243	.253	6.17	6.43

### PLUS247™ Outline



	=	Gate
2,	4	= Drain
3	=	Source

SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
Α	.190	.205	4.83	5.21
Α1	.090	.100	2.29	2.54
A2	.075	.085	1.91	2.16
۵	.045	.055	1.14	1.40
b2	.075	.087	1.91	2.20
b4	.115	.126	2.92	3,20
$\bigcirc$	.024	،031	0.61	0.80
	.819	.840	20.80	21.34
D1	.650	.690	16.51	17,53
D2	.035	.050	0.89	1.27
Ы	.620	.635	15.75	16.13
E1	.520	.560	13.08	14.22
υ	.215	BSC	5.45 BSC	
	.780	.810	19.81	20.57
L1	.150	.170	3.81	4.32
Q	.220	.244	5.59	6.20
R	.170	190،	4.32	4.83





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